

BB187 VHF variable capacitance diode Rev. 5 — 6 September 2011

**Product data sheet** 

# 1. Product profile

### 1.1 General description

The BB187 is a planar technology variable capacitance diode, in a SOD523 (SC-79) ultra small plastic SMD package. The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure.

### **1.2 Features and benefits**

- High linearity
- Excellent matching to 2 % DMA
- Ultra small plastic SMD package
- C<sub>d(25V)</sub>: 2.75 pF; C<sub>d(2V)</sub> to C<sub>d(25V)</sub> ratio: minimum 11
- Low series resistance.

### **1.3 Applications**

- Electronic tuning in VHF television tuners
- Voltage Controlled Oscillators (VCO).

### 2. Pinning information

Pin	Description	Simplified outline <sup>[1]</sup>	Symbol
1	cathode		
2	anode	1 2	$\overset{_{\ddagger}}{\not\vdash}$
			sym008

[1] The marking bar indicates the cathode.

# 3. Ordering information

Table 2. Orderin	g informatio	n	
Type number	Package		
	Name	Description	Version
BB187	SC-79	plastic surface mounted package; 2 leads	SOD523



-55

-55

+150

+125

°C

°C

# 4. Marking

Table 3. Marking	
Type number	Marking code
BB187	Х

# 5. Limiting values

Table 4.	Limiting values
In accorda	nee with the Abaelute

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>R</sub>	reverse voltage		-	32	V
V <sub>RM</sub>	peak reverse voltage	in series with a 10 k $\Omega$ resistor	-	35	V
I <sub>F</sub>	forward current		-	20	mA

# 6. Characteristics

T<sub>stg</sub>

Τj

#### Table 5. Characteristics

 $T_i = 25 \ ^{\circ}C$  unless otherwise specified.

storage temperature

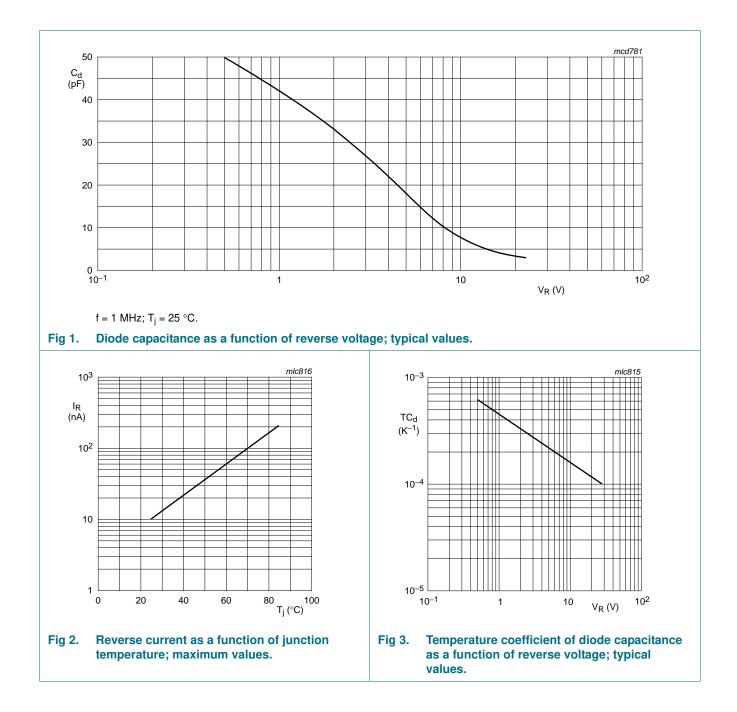
junction temperature

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>R</sub>	reverse current	see Figure 2	-	-		
		V <sub>R</sub> = 30 V	-	-	10	nA
		$V_R = 30 V; T_j = 85 °C$	-	-	200	nA
r <sub>s</sub>	diode series resistance	f = 470 MHz; $V_R$ = 5 V	-	-	0.75	Ω
C <sub>d</sub>	diode capacitance	f = 1 MHz;see <u>Figure 1</u> and <u>Figure 3</u>				
		V <sub>R</sub> = 2 V	29.3	-	34.2	pF
		V <sub>R</sub> = 25 V	2.57	2.75	2.92	pF
$\frac{C_{d(2V)}}{C_{d(25V)}}$	capacitance ratio	f = 1 MHz	11	-	-	
$\frac{\Delta C_d}{C_d}$	capacitance matching	V <sub>R</sub> = 2 V to 25 V; in a sequence of 10 diodes (gliding)	-	-	2	%

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# 7. Package outline

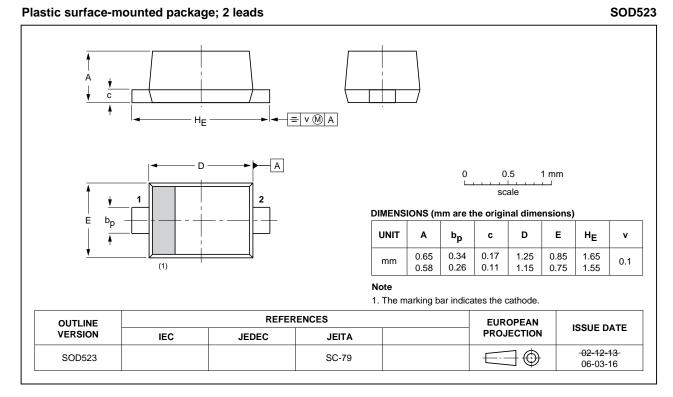


Fig 4. Package outline SOD523 (SC-79).

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# 8. Revision history

Table 6. Revision l	nistory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BB187 v.5	20110906	Product data sheet	-	BB187 v.4
Modifications:		of this data sheet has been re of NXP Semiconductors.	designed to comply v	vith the new identity
	<ul> <li>Legal texts</li> </ul>	have been adapted to the new	v company name whe	ere appropriate.
	<ul> <li>Package or</li> </ul>	utline drawings have been upd	ated to the latest vers	sion.
BB187 v.4 (9397 750 13835)	20041103	Product data sheet	-	BB187 v.3
BB187 v.3 (9397 750 09385)	20020220	Product specification	-	BB187 v.2
BB187 v.2 (9397 750 06459)	19991019	Product specification	-	BB187 v.1
BB187 v.1 (9397 750 06307)	19990915	Preliminary specification	-	-

# 9. Legal information

### 9.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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